

01-05-2007

FORM PTO-1595 (Rev. 07/05)
OMB No. 0651-0027
(exp 6/30/2008)



103357086

EET

U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 10024.0047
Attorney Customer Number: 22,852

To the Director of the U.S. Patents and Trademarks Office: Please record the attached original documents or copy thereof.

1. Name of conveying party:

Dae Young KIM

2. Name and address of receiving party:

Name:

Dongbu Electronics Co., Ltd.

Additional name of conveying party attached? ☐ Yes ☒ No

Internal Address:

3. Nature of conveyance/Execution Date:

Execution Dates: **December 7, 2006**

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Joint Research Agreement
- ☐ Government Interest Assignment
- ☐ Executive Order 9424, Confirmatory License
- ☐ Other

Street Address: 891-10, Daechi-dong, Gangnam-gu, Seoul, Korea, 135-280

City:

State:

Zip Code:

Additional name & Address attached?

☐ Yes☒ No

4. Application number or patent number:

☒ This document is being filed together with a new application.

A. Patent Application Number:

B. Patent Number:

12/28/2006 SSITHIB1 00000042 11648545

04 FC:8021

40.00 DP

Additional numbers attached?

☐ Yes☒ No

5. Name and address of to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved: 1

7. Total fee (37 CFR 3.41): \$40

- ☐ Authorized to be charged by credit card
- ☐ Authorized to be charged to deposit account
- ☒ Enclosed (Please charge deficiency to deposit account)
- ☐ None required (government interest not affecting title)

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

8. Payment Information

Street Address: 901 New York Avenue, NW

a. Credit Card Last 4 Numbers _____

City: Washington, D.C.

Expiration Date _____

State: Zip: 20001-4413

b. Deposit Account No.: 06-0916

Authorized User Name _____

8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ernest F. Chapman
Registration No. 25,961

Signature

December 27, 2006

Date

Total number of pages including cover sheet, attachments and documents: 2

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, PO box 1450, Alexandria, VA 22313-1450

PATENT
REEL: 018744 FRAME: 0417

ASSIGNMENT

WHEREAS I/We, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on , 20 (Application No.); and

WHEREAS, Dongbu Electronics Co., Ltd.
a corporation of Republic of Korea

whose post office address is 891-10, Daechi-dong, Gangnam-gu, Seoul, Korea 135-280

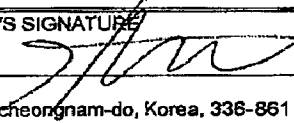
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY further covenant and agree that We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. , filed) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, We have hereunto set our hands.

1. FULL NAME OF SOLE OR FIRST ASSIGNOR Dae Young KIM	ASSIGNOR'S SIGNATURE 	DATE 2006. 12. 07
ADDRESS 105-425, Chwon Apt., 21-3, Deokji-ri, Eumbong-myeon, Asan-si, Chungcheongnam-do, Korea, 336-861		CITIZENSHIP Republic of Korea